LBB110

DUAL POLE OptoMOS® Relay

	LBB110	Units
Load Voltage	350	V
Load Current	120	mA
Max R_{ON}	35	Ω

Features

- Small 8 Pin DIP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 3750V_{RMS} Input/Output Isolation
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount and Tape & Reel Versions Available

Applications

- Telecommunications
  - Telecom Switching
  - Tip/Ring Circuits
  - Modem Switching (Laptop, Notebook, Pocket Size)
  - Hookswitch
  - Dial Pulsing
  - Ground Start
  - Ringer Injection
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
  - Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The LBB110 is a Dual 1 Form B solid state relay that has two independently controlled optically coupled MOSFETs. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS® architecture to provide 3750 V_{RMS} of input to output isolation. The optically coupled inputs are controlled by highly efficient GaAIAs infrared LEDs. Dual pole OptoMOS relays provide a more compact design solution than discrete single pole relay in a variety of applications. The dual pole relays save board space by incorporating both relays in a single 8-pin package.

Approvals

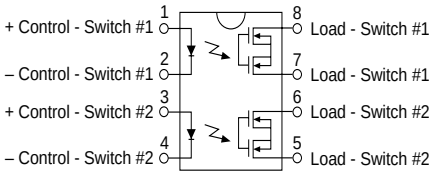
- UL Recognized: File Number E76270
- CSA Certified: File Number LR 43639-10
- BSI Certified to:
  - BS EN 60950:1992 (BS7002:1992) Certificate #: 7344
  - BS EN 41003:1993 Certificate #: 7344

Ordering Information

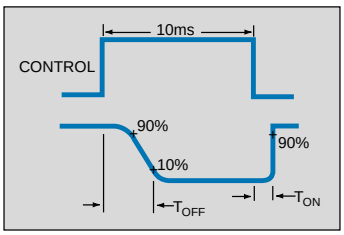
Part #	Description
LBB110	8 Pin DIP (50/Tube)
LBB110P	8 Pin Flatpack (50/Tube)
LBB110PTR	8 Pin Flatpack (1000/Reel)
LBB110S	8 Pin Surface Mount (50/Tube)
LBB110STR	8 Pin Surface Mount (1000/Reel)

Pin Configuration

LBB110 Pinout



Switching Characteristics of Normally Closed (Form B) Devices



Absolute Maximum Ratings (@ 25° C)

Parameter	Min	Typ	Max	Units
Input Power Dissipation	-	-	150[1]	mW
Input Control Current	-	-	50	mA
Peak (10ms)	-	-	1	A
Reverse Input Voltage	-	-	5	V
Total Power Dissipation	-	-	800[2]	mW
Isolation Voltage Input to Output	3750	-	-	V_{RMS}
Operational Temperature	-40	-	+85	°C
Storage Temperature	-40	-	+125	°C
Soldering Temperature (10 Seconds Max.) DIP Package	-	-	+260	°C
Flatpack/Surface Mount Package	-	-	+220	°C

[1] Derate Linearly 1.33 mw/°C

[2] Derate Linearly 6.67 mw/°C

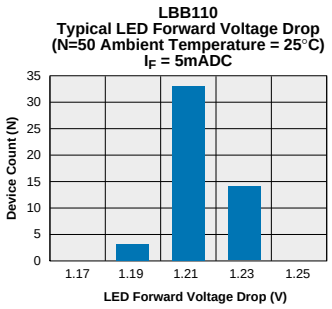
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this data sheet is not implied. Exposure of the device to the absolute maximum ratings for an extended period may degrade the device and effect its reliability.

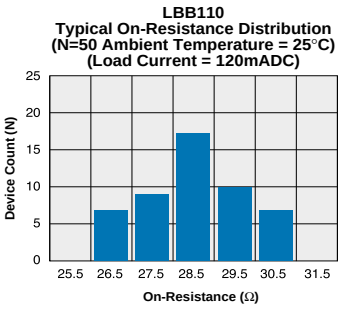
Electrical Characteristics

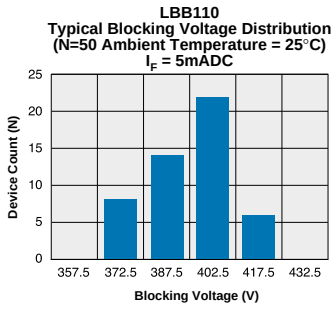
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Load Voltage (Peak)	-	V_L	-	-	350	V
Load Current* (Continuous)	-	I_L	-	-	120	mA
Peak Load Current	10ms	I_{LPK}	-	-	350	mA
On-Resistance	I_L=120mA	R_{ON}	-	25	35	Ω
Off-State Leakage Current	V_L=350V	-	-	-	1	µA
Switching Speeds						
Turn-On	I_F=5mA,V_L=10V	T_{ON}	-	-	3	ms
Turn-Off	I_F=5mA,V_L=10V	T_{OFF}	-	-	3	ms
Output Capacitance	50V; f=1MHz	C_{OUT}	-	25	-	pF
Input Characteristics @ 25°C						
Input Control Current	I_L=120mA	I_F	5	-	50	mA
Input Dropout Current	-	I_F	0.4	0.7	-	mA
Input Voltage Drop	I_F=5mA	V_F	0.9	1.2	1.4	V
Reverse Input Voltage	-	V_R	-	-	5	V
Reverse Input Current	V_R=5V	I_L	-	-	10	µA
Input to Output Capacitance	-	$V_{C/O}$	-	3	-	pF
Input to Output Isolation	-	$V_{I/O}$	3750	-	-	V_{RMS}

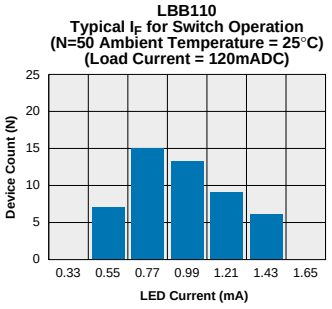
*Note: If both poles operate simulataneously load current must be derated so as not to exceed the package power dissipation value.

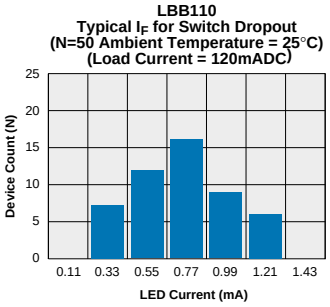
PERFORMANCE DATA*

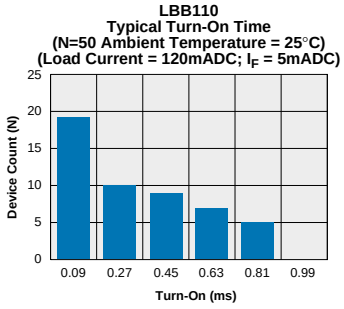


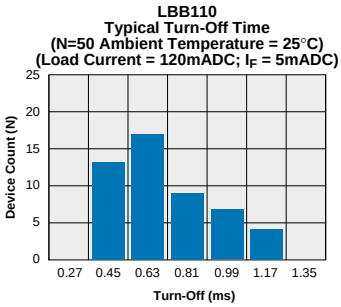


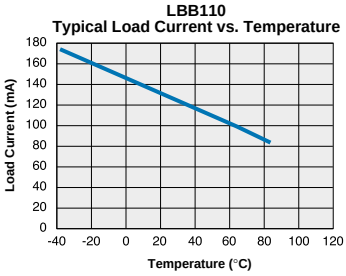


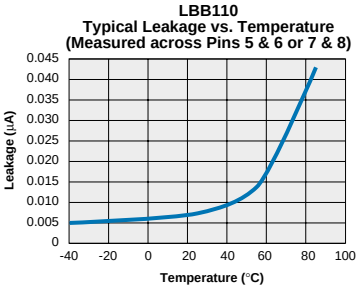


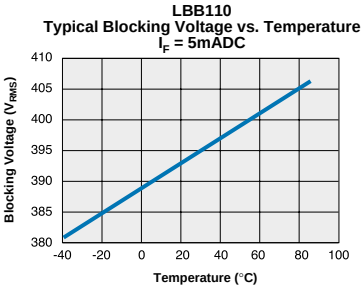


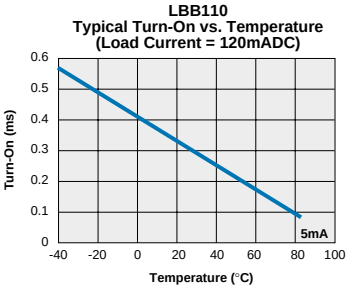


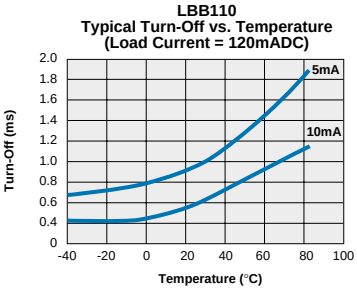






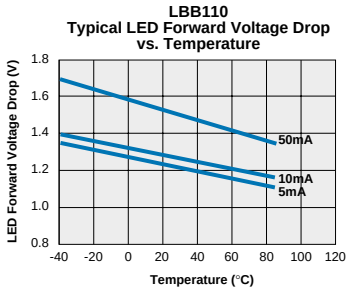


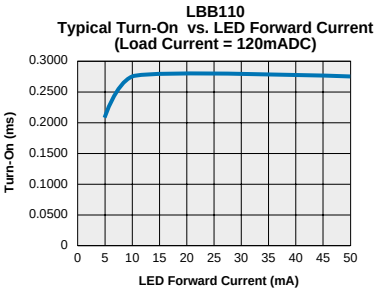


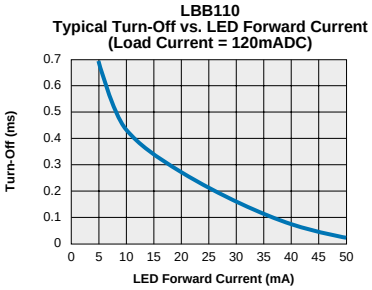


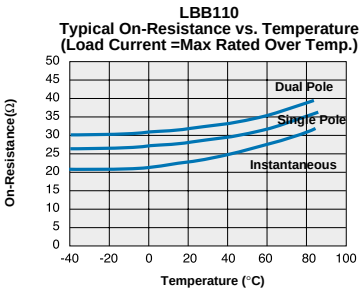
The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

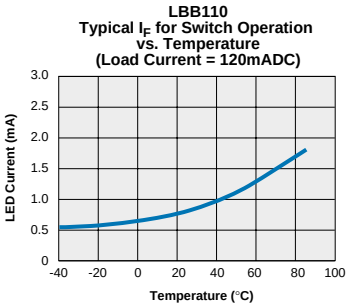
PERFORMANCE DATA*

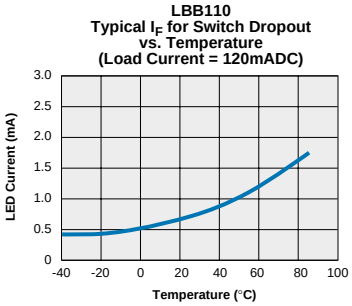


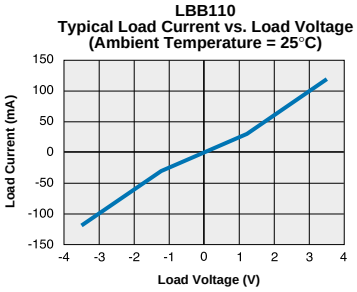


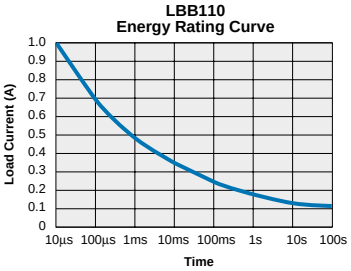












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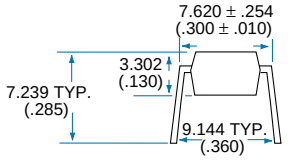
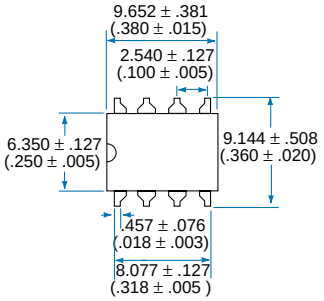
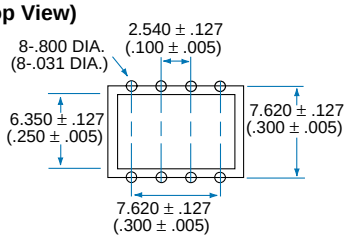
Mechanical Dimensions

8 Pin DIP Through Hole (Standard)

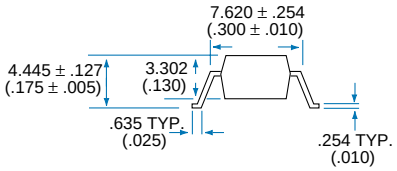


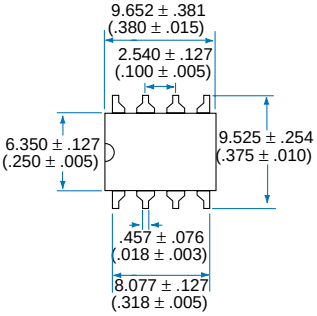


PC Board Pattern (Top View)

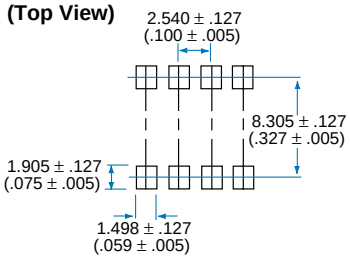


8 Pin DIP Surface Mount ("S" Suffix)

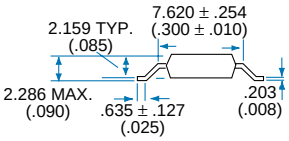


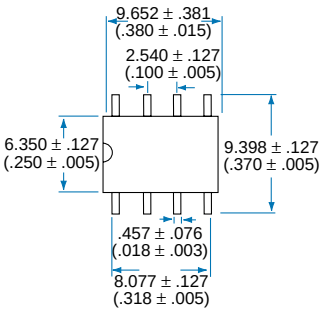


PC Board Pattern (Top View)

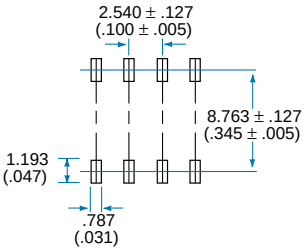


8 Pin Flatpack ("P" Suffix)





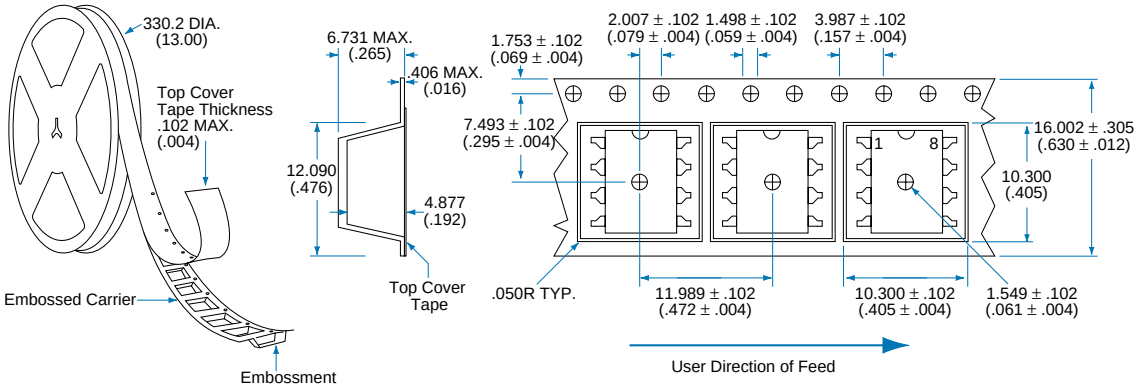
PC Board Pattern (Top View)



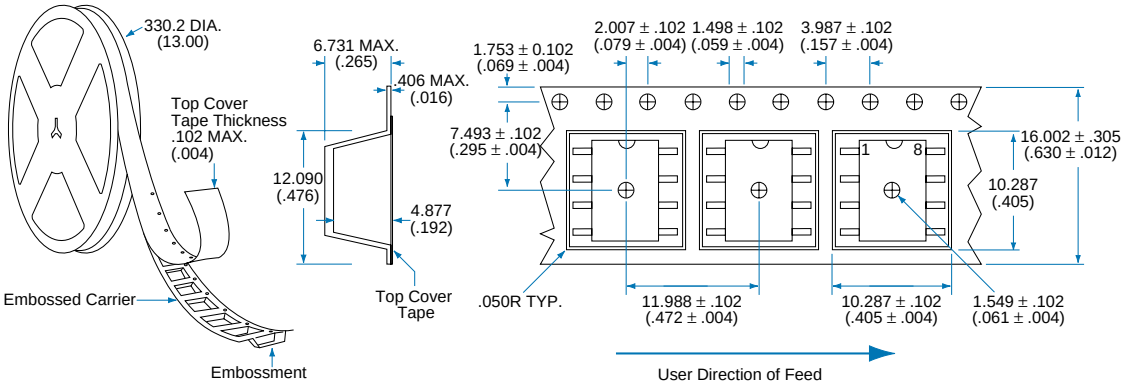
Dimensions
mm
(inches)

Mechanical Dimensions

Tape and Reel Packaging for 8 Pin Surface Mount Package



Tape and Reel Packaging for 8 Pin Flatpack Package



Dimensions
mm
(inches)

CLARE

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Specification: DS-LBB110-R6
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1/25/01